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TSMC99-646BCC

February 8, 2004

TO: Commissioner for Patents
P.O. Box 1450
Alexandria, VA. 22313-14509

Fr: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Ave.
Poughkeepsie, N.Y. 12603

Subject: [Serial No. 09/846,536 05/02/01]

W. T. Chu et al

"SELF ALIGNED, LOW CONTACT RESISTANCE,
VIA FABRICATION PROCESS"

[GRP. Art. Unit 2811 O. Nadav]

RESPONSE PATENT OFFICE ACTION

Dear Sir;

In response to the FINAL Office Action dated January 02, 2004, please amend the identified application for patent as follows:

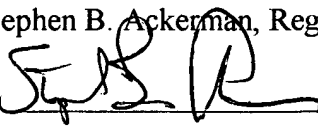
The commissioner is hereby authorized to charge payment of any additional fees involved with added Claims and the like to Deposit Account No. 19-0033

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA. 22313-1450, on March 8, 2004.

Stephen B. Ackerman, Reg. No. 37,761

Signature



Date

3/8/04

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Amendments to Claim begin on page 3.

Remarks begin on page 6.